

## SKNa 86, SKRa 86



## Stud Diode

## Avalanche Diodes

**SKNa 86**  
**SKRa 86**

## Features

- Avalanche type reverse characteristic of 2000 V
- Hermetic metal cases with glass insulator
- Threaded studs ISO M8 or 1/4"-28 UNF-2A<sup>2)</sup>
- **SKN:** anode to stud
- **SKR:** cathode to stud

## Typical Applications

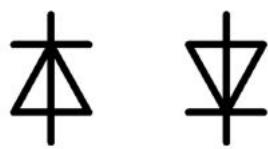
- DC supply for magnets or solenoids (brakes, valves, etc.)
- Field coil supply for DC motors
- Series connections for high voltage applications like dust precipitators

1) Mounting with grease-like thermal compound or joint contact compound

2) M8x1,25 is standard; "UNF" should be added in description for 1/4"-28 UNF 2A.

$V_{RSM}$ V	$V_{(BR)min}$ V	$I_{FRMS} = 185 \text{ A}$ (maximum value for continuous operation) $I_{FAV} = 85 \text{ A}$ (sin. 180; $T_c = 130 \text{ }^\circ\text{C}$ )	
1400	1400	SKNa 86/14	SKRa 86/14
1800	1800	SKNa 86/18	SKRa 86/18
2000	2000	SKNa 86/20	SKRa 86/20

Symbol	Condition	Values	Units
$I_{FAV}$	sin. 180 ; $T_c = 100 \text{ }^\circ\text{C}$	115	A
$I_{FSM}$	$T_{vj} = 25 \text{ }^\circ\text{C} ; 10 \text{ ms}$ $T_{vj} = 180 \text{ }^\circ\text{C} ; 10 \text{ ms}$	1500 1275	A A
$i^2t$	$T_{vj} = 25 \text{ }^\circ\text{C} ; 8,3 \dots 10 \text{ ms}$ $T_{vj} = 180 \text{ }^\circ\text{C} ; 8,3 \dots 10 \text{ ms}$	11250 8125	A <sup>2</sup> s A <sup>2</sup> s
$V_F$ $V_{(TO)}$	$T_{vj} = 25 \text{ }^\circ\text{C}, I_F = 150 \text{ A}$ $T_{vj} = 180 \text{ }^\circ\text{C}$	max. 1,3 0,85	V V
$r_T$	$T_{vj} = 180 \text{ }^\circ\text{C}$	3	mΩ
$I_R$	$T_{vj} = 180 \text{ }^\circ\text{C} ; V_R = V_{(BR)min}$	10	mA
$P_{RSM}$	$T_{vj} = 180 \text{ }^\circ\text{C}, t_P = 10 \mu\text{s}$	20	kW
$R_{th(j-c)}$ $R_{th(c-s)}$		0,4 0,2	K/W K/W
$T_{vj}$		-40 ... +180	°C
$T_{stg}$		-40 ... +180	°C
$V_{isol}$ $M_s$	M8 Stud 1/4"-28 UNF 2A M8 Stud (lubricated) <sup>1)</sup> 1/4"-28 UNF 2A (lubricated) <sup>1)</sup>	- 4 2,5 3 2 5 * 9,81 20	V~ Nm Nm Nm Nm m/s <sup>2</sup> g
a m	approx.		
Case		E 10	


**SKN**      **SKR**

# SKNa 86, SKRa 86

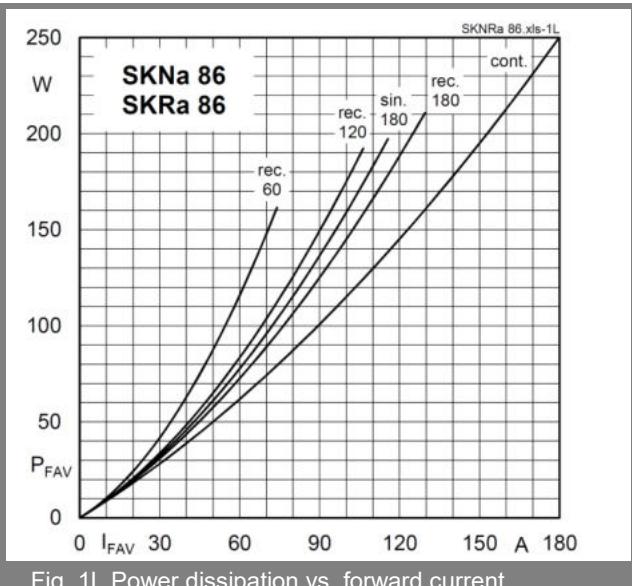


Fig. 1L Power dissipation vs. forward current

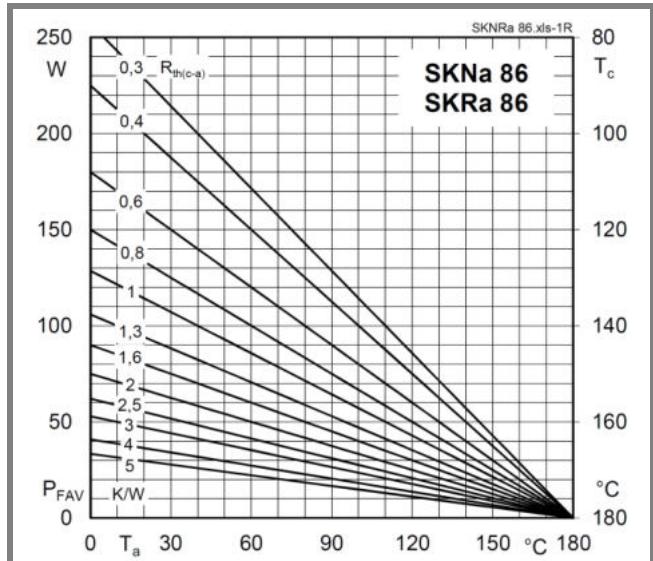


Fig. 1R Power dissipation vs. ambient temperature

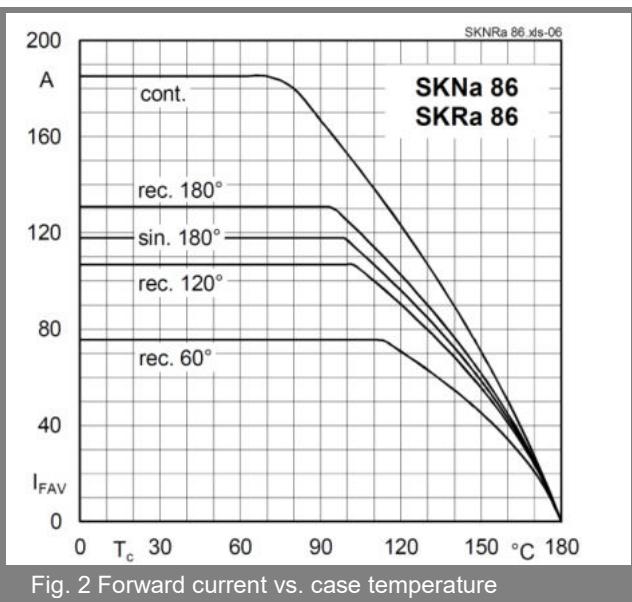


Fig. 2 Forward current vs. case temperature

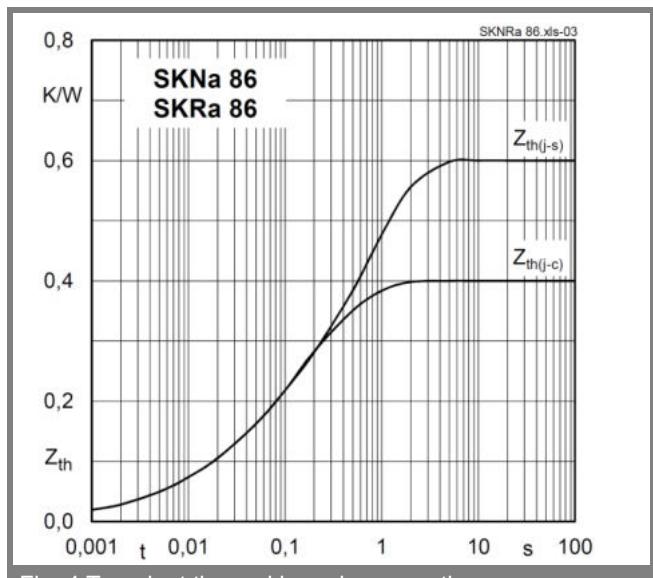


Fig. 4 Transient thermal impedance vs. time

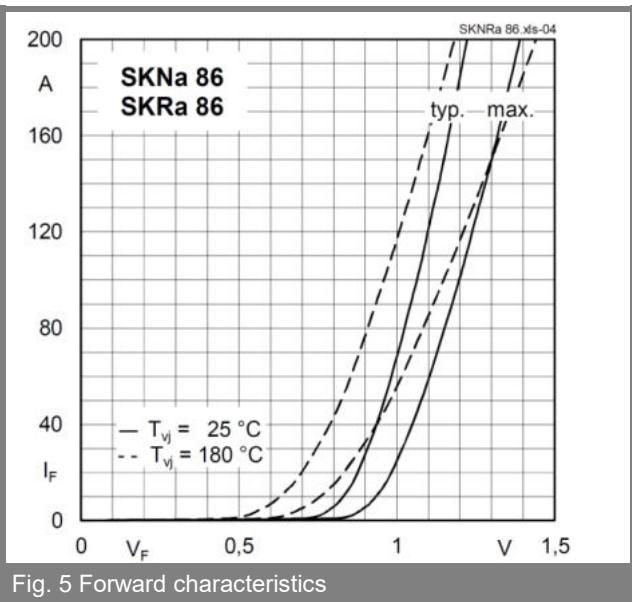


Fig. 5 Forward characteristics

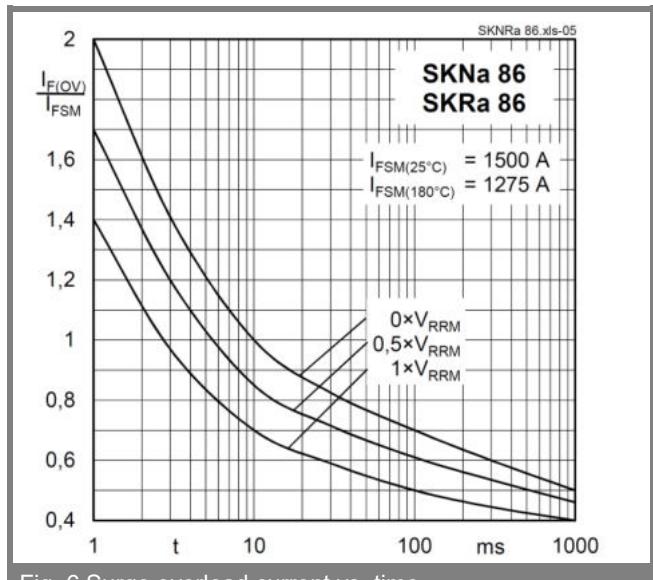
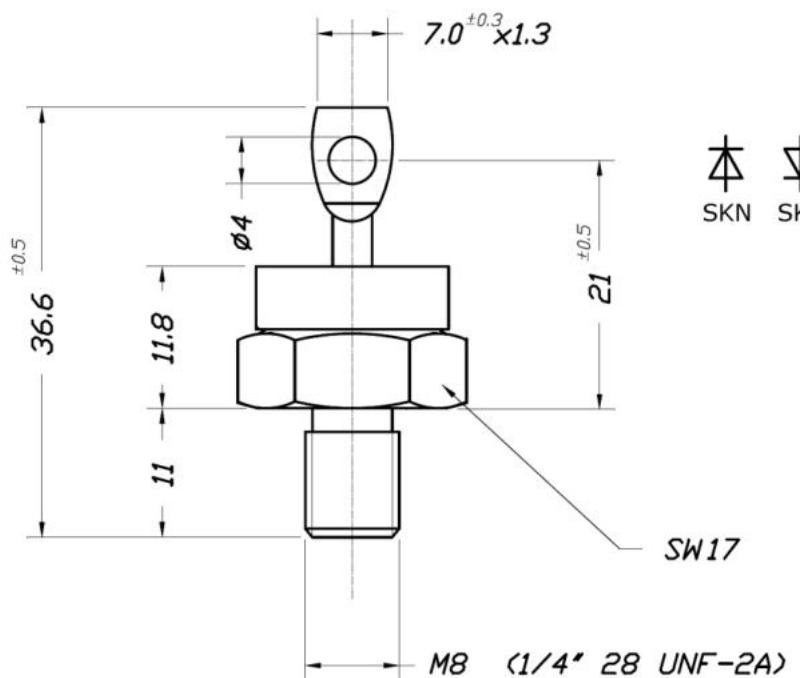


Fig. 6 Surge overload current vs. time

Dimensions in mm



## Case E10 (JEDEC: DO-203 AB (DO-5))

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